TAOGLAS®

Datasheet

DSGP.1575.18.2.A.02

Description:

GPS L1 / GALILEO E1 1575.42MHz 18*18*2mm Ceramic Patch SMD Antenna

Features:

- 2.4 dBi Peak Gain for GPS/GALILEO Band
- Dimensions: 18 x 18 x 2mm
- SMD Direct Mount Ceramic Patch Antenna
- TS16949 Approved
- RoHS & Reach Compliant

1. Introduction

The DSGP.1575.18.2.A.02 is a ceramic GPS L1 / GALILEO E1 passive patch antenna, 18mm square, with a low profile of 2mm thickness. It is designed for applications in space constrained navigation devices, vehicle tracking/fleet management systems, as well as telematics devices.

The antenna has been tuned on a 50 x 50 mm ground plane, working at 1575.42MHz with a 2.4 dBi gain. The ceramic patch is mounted via SMT process, ideal for high volume low cost assembly. It is manufactured and tested in a TS16949 first tier automotive approved facility.

For further optimization to customer specific device environments where ground-plane size is different, custom tuned patch antennas can be supplied. For more details please contact your regional Taoglas sales office.

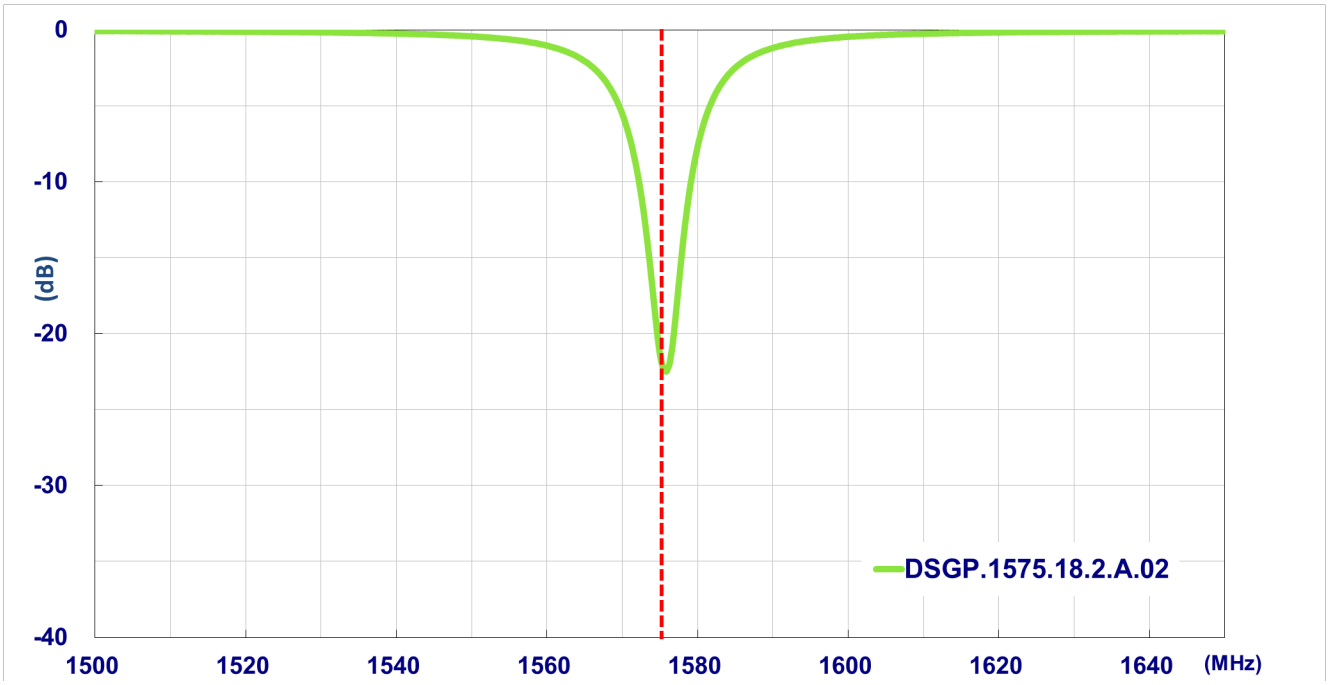
2. Specifications

GNSS Frequency Bands Covered							
GPS/QZSS	L1 1575.42MHz	L2 1227.6MHz	L5 1176.45MHz	L6 1278.75MHz			
	☑	☐	☐	☐			
GLONASS	L5R 1176.45MHz	L3PT 1201.5MHz	L2PT 1246MHz	L1CR 1575.42MHz	L1PT 1602MHz		
	☐	☐	☐	☑	☐		
Galileo	E5a 1176.45MHz	E5b 1201.5MHz	E4 1215MHz	E3 1256MHz	E6 1278.75MHz	E2 1561MHz	L1 1575.42MHz
	☐	☐	☐	☐	☐	☐	☑
BeiDou	B1 1561MHz	B2 1207.14MHz	B3 1268.52MHz				
	☐	☐	☐				
Compass	E5B(B2)/ E6(B3) 1268.56MHz	E2(B1) 1561MHz					
	☐	☐					
SBAS	Omnistar 1542.5MHz	WAAS/EGN OS 1575.42MHz					
	☐	☑					

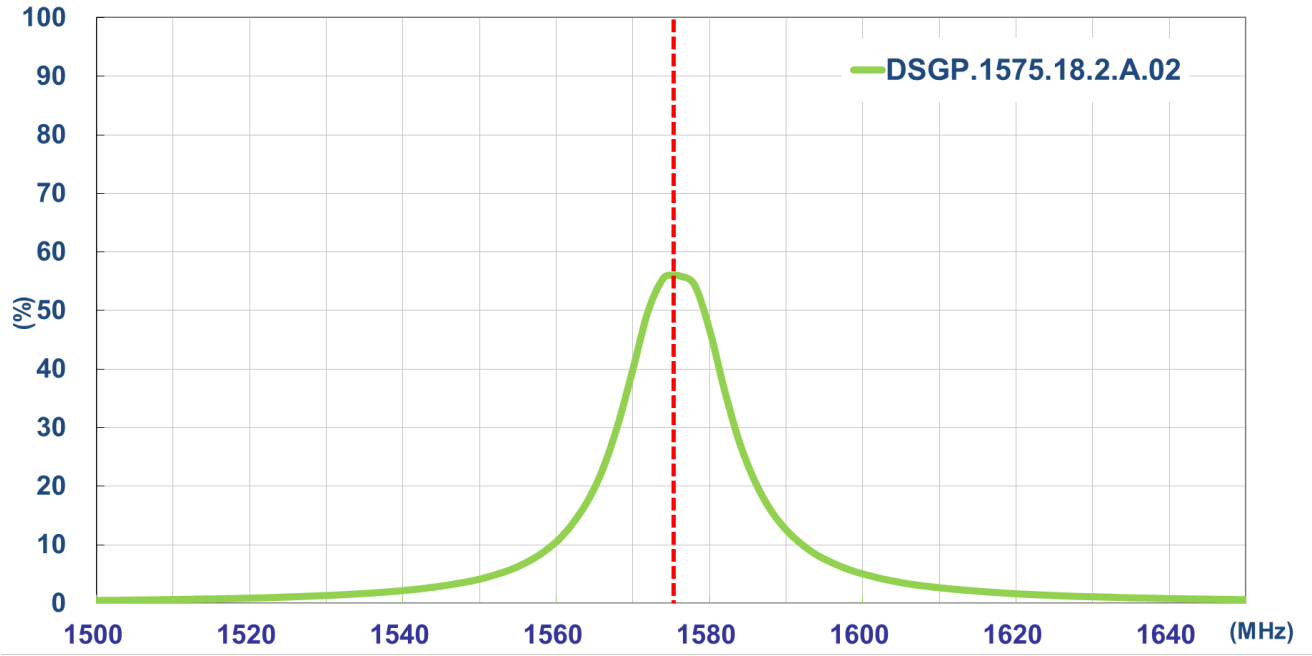
Electrical	
Frequency (MHz)	**1575.42**
VSWR (max.)	2.0:1
Passive Antenna Efficiency (%)	55.94
Passive Antenna Gain at Zenith (dBi)	2.4
Return Loss (dB)	<-10
Impedance	50Ω
Mechanical	
Height	255 ± 5 mm
Base Diameter	16.05 ± 0.2 mm
Whip Diameter	4 ± 0.2 mm
Casing	ABS
Connector	TNC Male
Environmental	
Temperature Range	-40°C to 85°C
Humidity	Non-condensing 65°C 95% RH
Moisture Sensitivity Level (MSL)	3 (168 Hours)

3. Antenna Characteristics

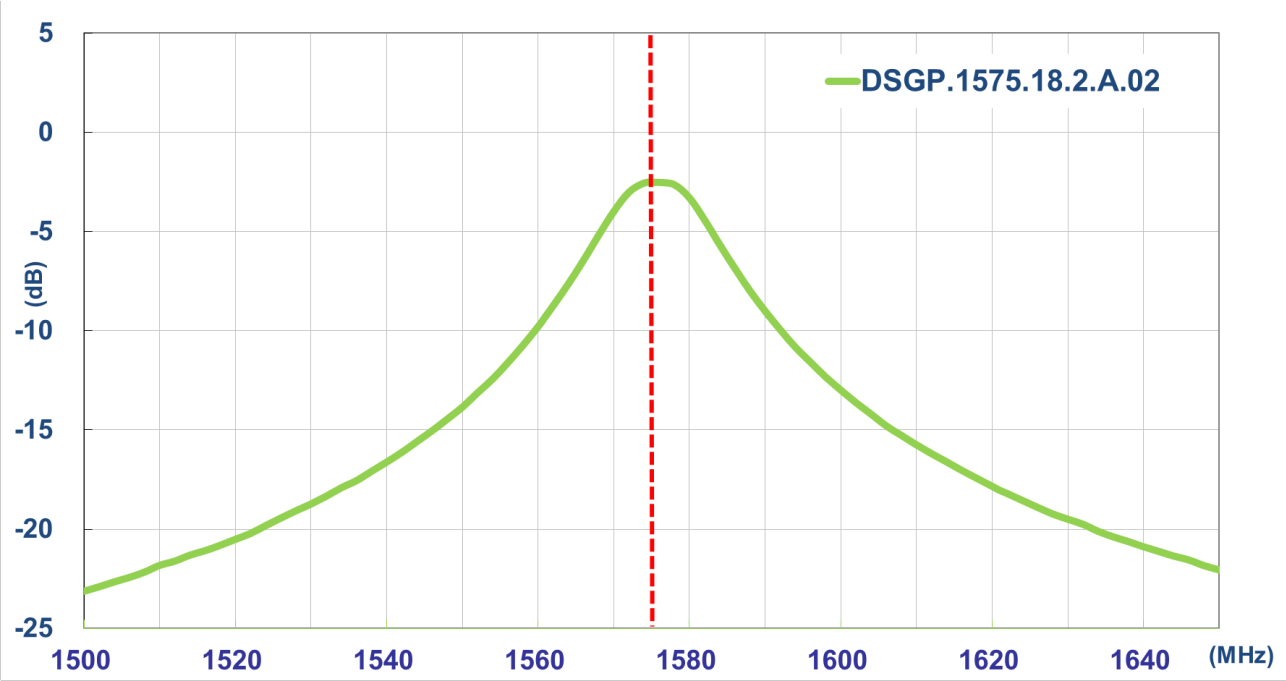
3.1 Return Loss



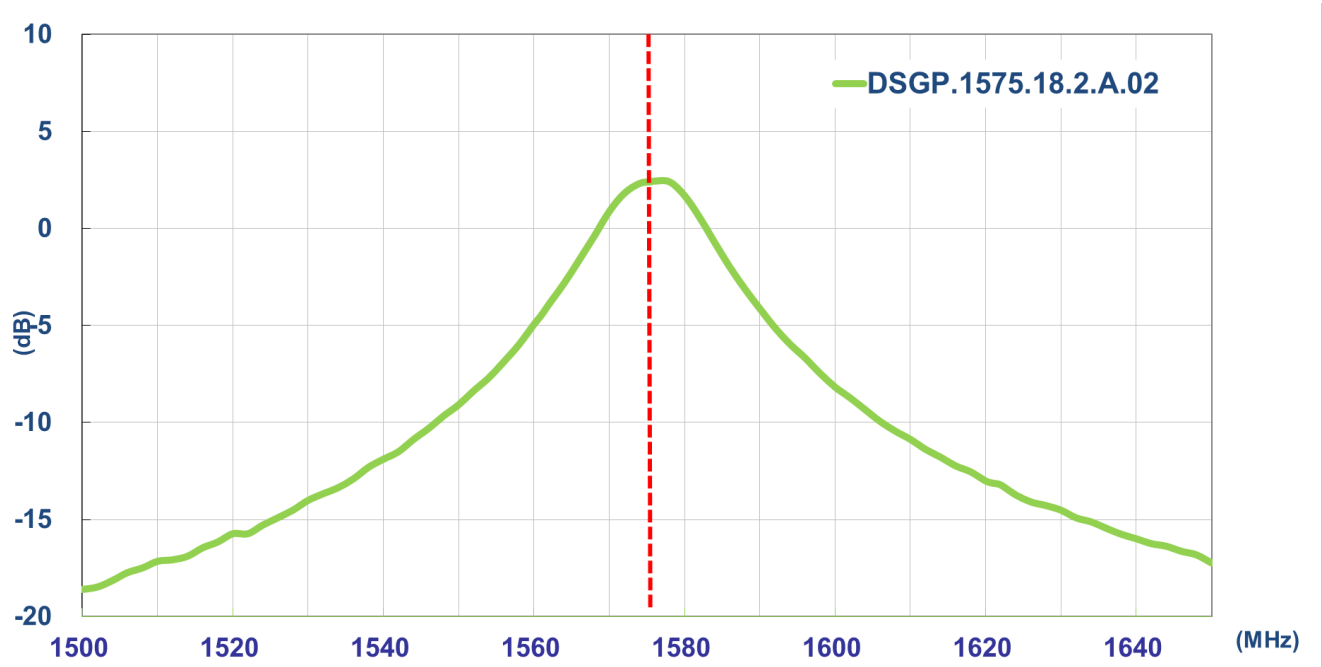
3.2 Efficiency



3.3 Average Gain

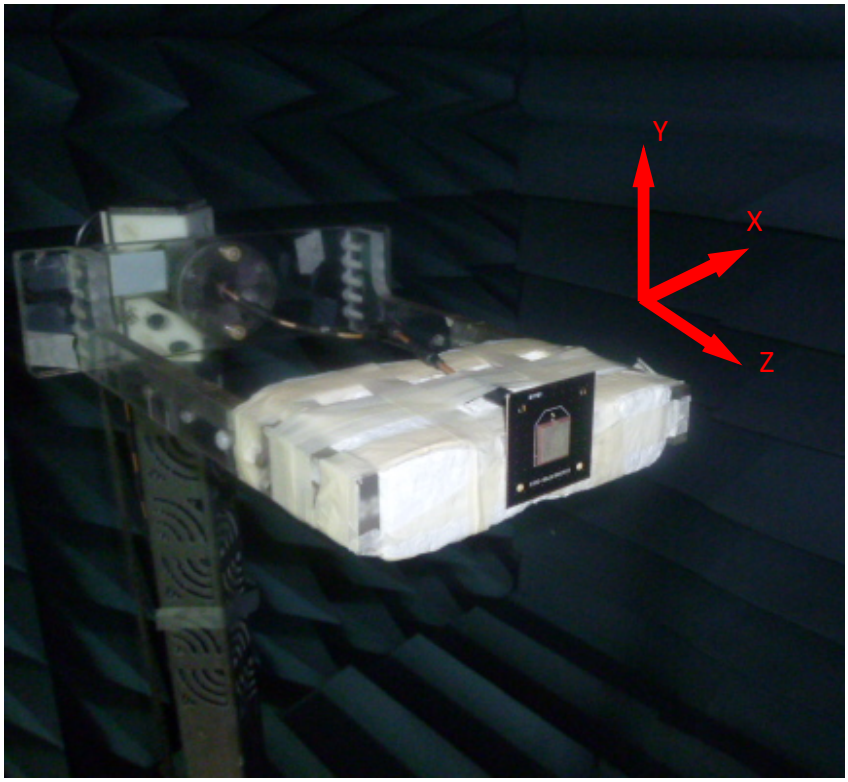


3.4 Peak Gain



4. Radiation Patterns

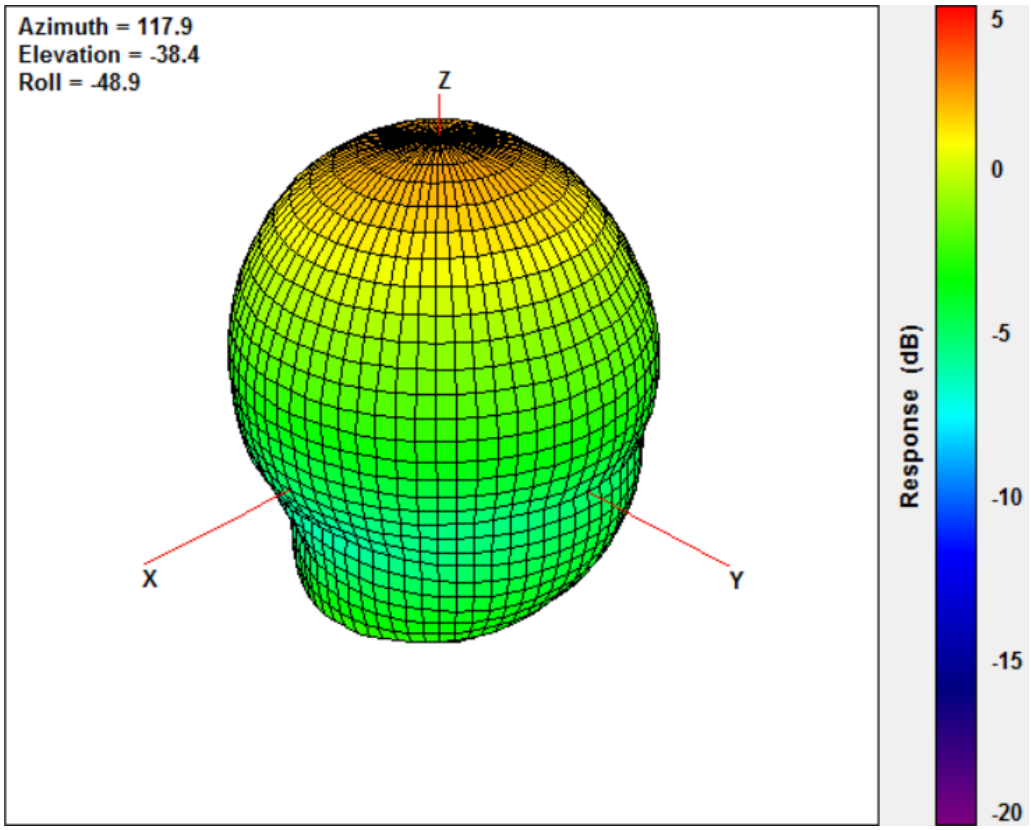
4.1 Test Setup

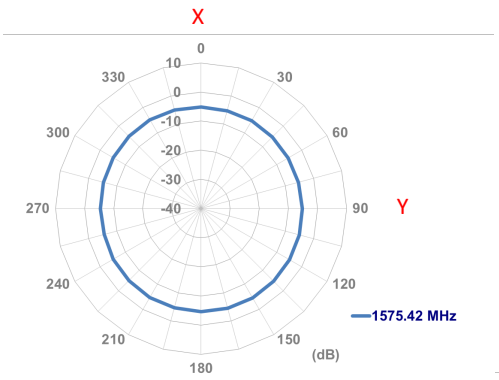
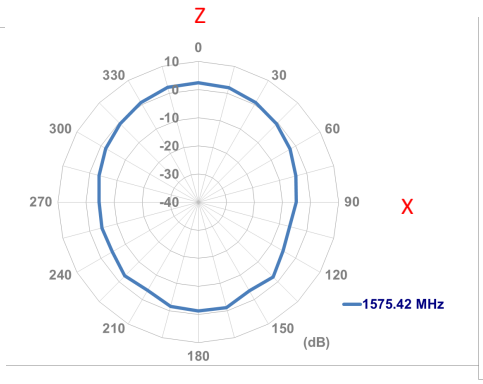
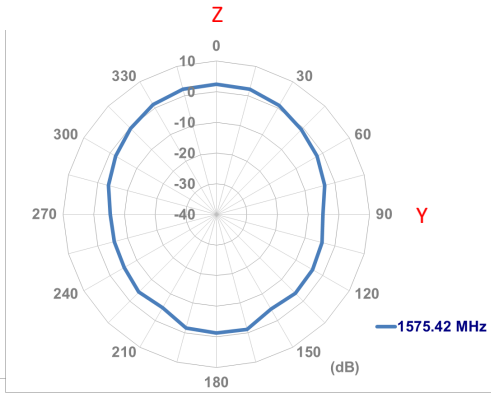


On Evaluation Board

Taoglas Part number: DSGPD.18B

4.2 1575.42MHz 3D and 2D Radiation Patterns



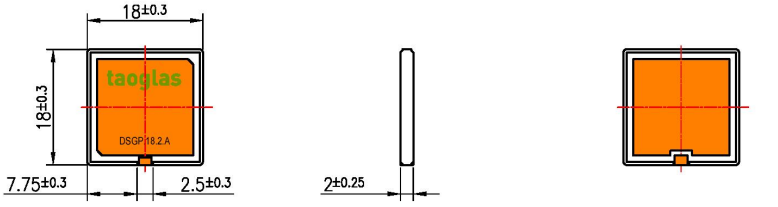
XY Plane	XZ Plane	YZ Plane
		

5. Mechanical Drawing (Units: mm)

ISO NO: EDW-18-8-0728	<Release>

REV	ZONE	DESCRIPTION	ENG	APPROVED	ISSUED DATE
A	ALL	Initial Design	Eva	Paul	2018/08/31
B	F5	Correct Top View.(ECR-18-8-135)	Bonnie	Joey	2018/12/11

Top View B Side View Bottom View

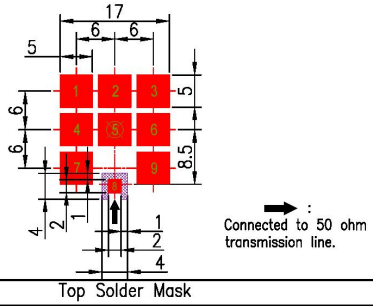


SCALE: 1/1

Foot Print

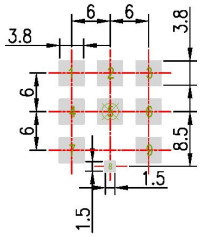
Top Copper

Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size.
They should be connected to GND.



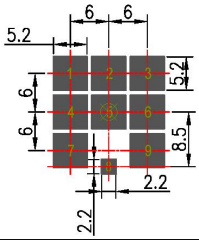
Top Solder Paste

Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size.

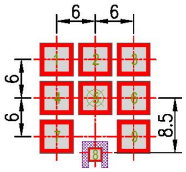


Top Solder Mask

Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size,
This drawing is a negative of solder mask. Black regions are anti-mask.



Composite Diagram



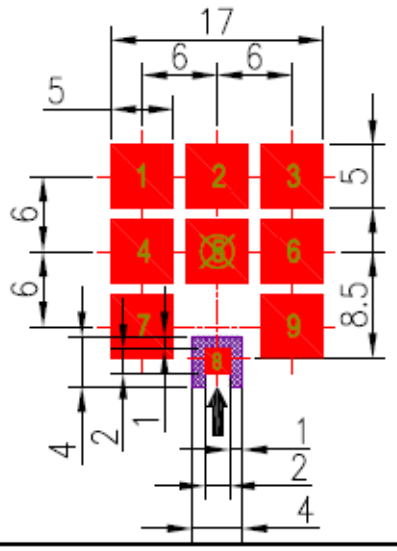
NOTE:
1. Ag Plated area
2. Solder Mask area
3. Copper area
4. Paste area
5. Copper Keepout Area
6. Copper keepout should extend through all PCB layers.
7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
8. The dimension tolerances should follow standard PCB manufacturing guidelines

UNLESS OTHERWISE SPECFIED TOLERANCES ON: .X± 0.2 XX.± 0.5 .XX± 0.1 X.± 0.3 .XXX± 0.05	DATE: 2015/04/15	MAT'L:	TAOGLAS. TW Design Centre This drawing and its inherent design concepts are property of Taoglas. Not to be copied or given to third parties without the written consent of Taoglas.	REV B
	UNIT: mm	FINISH:		
	THIRD ANGLE PROJECTION	SCALE: 1/1	TITLE. : GPS 1575MHz SMT Ceramic Direct Mount Antenna 18*18*2mm	
APPROVED BY: Wayne / CHECKED BY: Aine / DRAWN BY: Haley / CUSTOMERS SIGNATURE / DATE			PART NO. : DSGP.1575.18.2.A.02	

6. Footprint

Top Copper

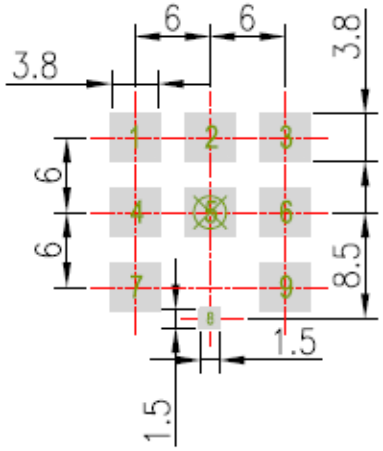
Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size.
They should be connected to GND.



: Connected to 50 ohm transmission line.

Top Solder Paste

Pads 1, 2, 3, 4, 5, 6, 7 and 9 are the same size.



Top Solder Mask

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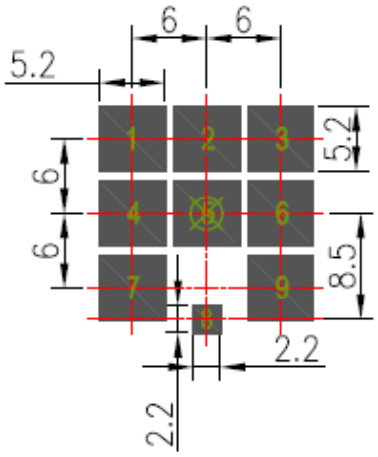
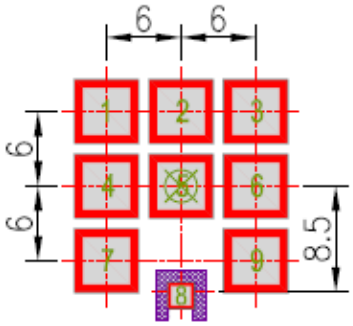


Composite Diagram



NOTE:
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2. Solder Mask area
3. Copper area
4. Paste area
5. Copper Keepout Area

6. Copper keepout should extend through all PCB layers.

7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.

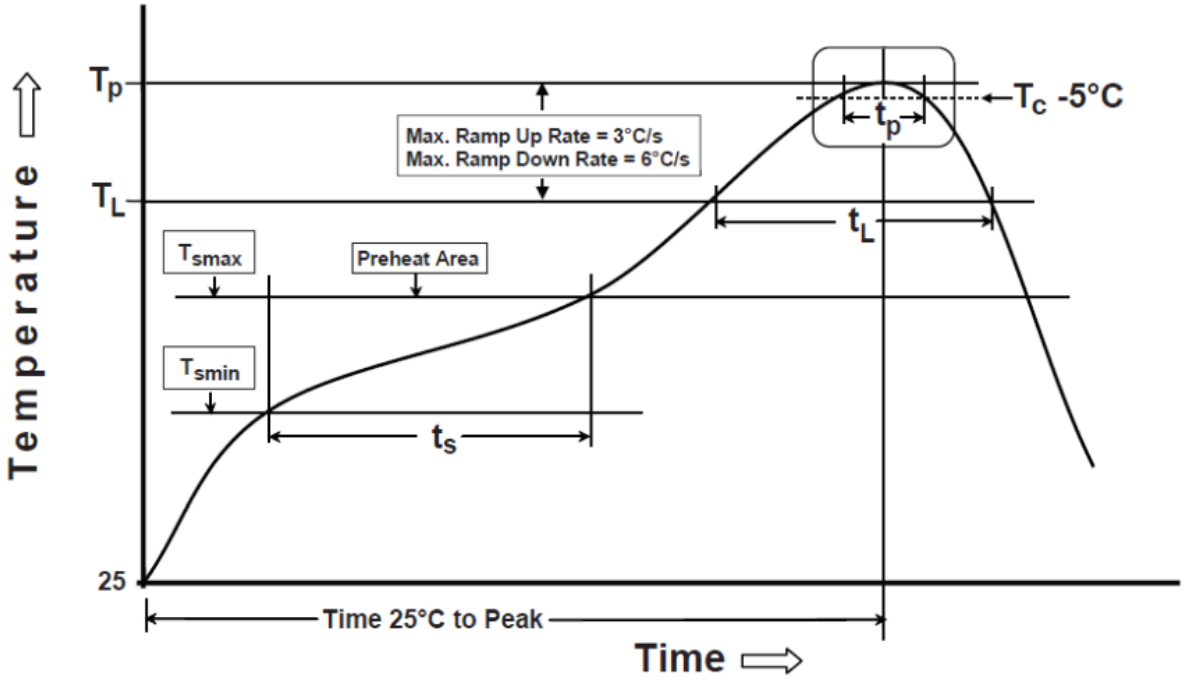
8. The dimension tolerances should follow standard PCB manufacturing guidelines

7. Recommended Reflow Soldering Profile

DSGP.1575.18 can be assembled following Pb-free assembly. According to the Standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follows:

Phase	Profile Features	Pb-Free Assembly (SnAgCu)
PREHEAT	Temperature Min (Tsmin) Temperature Max (Tsmax) Time(ts) from (Tsmin to Tsmax)	150°C 200°C 60-120 seconds
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)
REFLOW	Temperature (TL) Total Time above TL (tL)	217°C 30-100 seconds
PEAK	Temperature (TP) Time(tp)	260°C 2-5 seconds
RAMP-DOWN	Rate	3°C/second(max)
Time from 25°C to Peak Temperature		8 minutes max.
Composition of solder paste		96.5Sn/3Ag/0.5Cu
Solder Paste Model		SHENMAO PF606-P26

The graphic shows temperature profile for component assembly process in reflow ovens

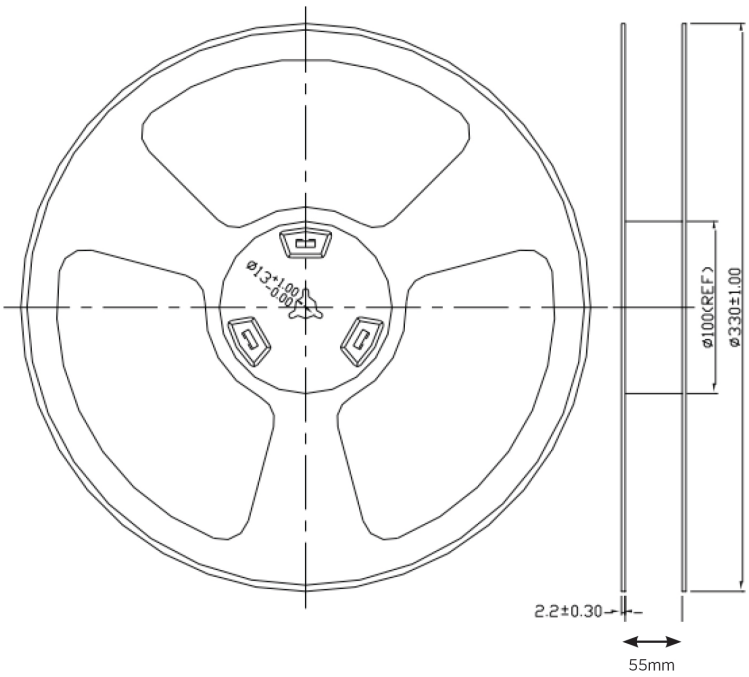


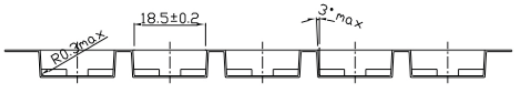
Soldering Iron condition : Soldering iron temperature 270°C±10°C.

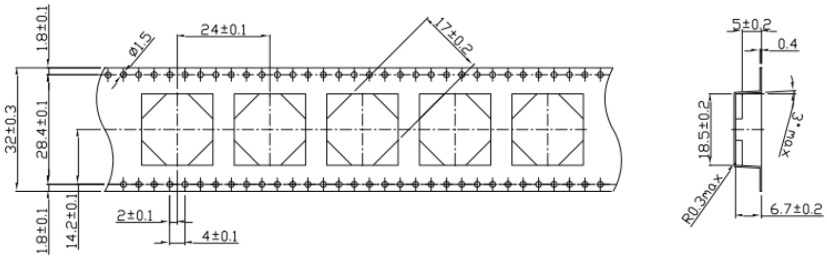
Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron temperature over270°C±10°C or 3 seconds, it will make cause component surface peeling or damage.

8. Packaging

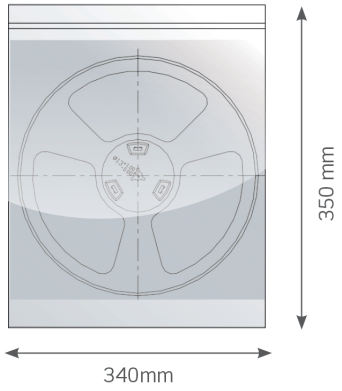
200 pc DSGP.1575.18.2.A.02 per reel
Dimensions - Ø330*55mm
Weight - 800g



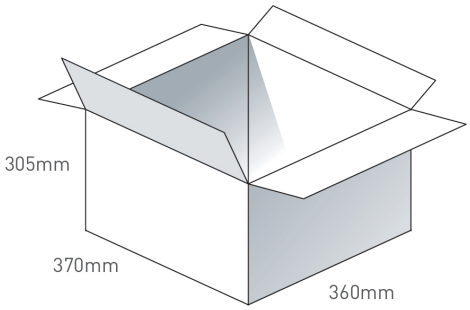




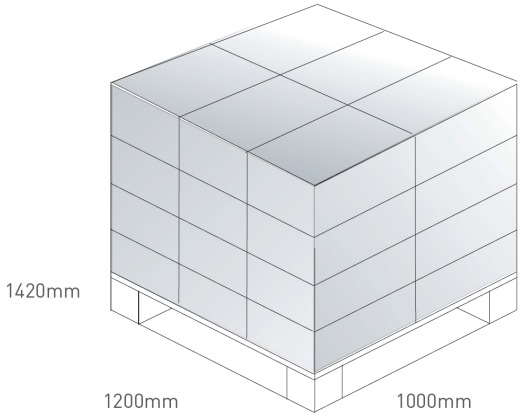
1 pc reel in small in Anti-static Bag
Dimensions - 340*350*70mm
Weight - 1.2Kg



4 Reels i n Anti-static Bags
800 pcs in one carton
Carton Dimensions - 370*360*305mm
Weight - 5.6Kg



Pallet Dimensions 1200*1000*1420mm
24 Cartons per Pallet
6 Cartons per layer
4 Layers



Changelog for the datasheet

SPE-17-8-029 – DSGP.1575.18.2.A.02

Revision: C (Current Version)	
Date:	2021-09-07
Changes:	Fixed Alignment of radiation patterns section. Added MSL rating. Fixed Font in tables.
Changes Made by:	Erik Landi

Previous Revisions

Revision: B	
Date:	2019-09-17
Changes:	Updated Drawing
Changes Made by:	Jack Conroy

Revision: A (Original First Release)	
Date:	2017-05-22
Notes:	
Author:	Jack Conroy

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